

SKiiP 11NAB12T4V1



MiniSKiiP® 1

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Features

- Trench 4 IGBT's
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised file no. E63532

Typical Applications*

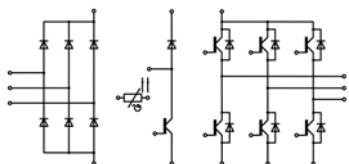
- Inverter up to 8 kVA
- Typical motor power 4 kW

Remarks

- V_{CEsat} , V_F = chip level value
- Case temp. limited to $T_C = 125^\circ\text{C}$ max. (for baseplateless modules $T_C = T_S$)
- product rel. results valid for $T_j \leq 150$ (recomm. Top = $-40 \dots +150^\circ\text{C}$)

Absolute Maximum Ratings

Symbol	Conditions		Values	Unit
Inverter - IGBT				
V _{CES}	T _j = 25 °C		1200	V
I _C	T _j = 150 °C	T _s = 25 °C	12	A
		T _s = 70 °C	12	A
I _C	T _j = 175 °C	T _s = 25 °C	12	A
		T _s = 70 °C	12	A
I _{Cnom}			8	A
I _{CRM}	I _{CRM} = 3 x I _{Cnom}		24	A
V _{GES}			-20 ... 20	V
t _{psc}	V _{CC} = 800 V V _{GE} ≤ 15 V V _{CES} ≤ 1200 V	T _j = 150 °C	10	µs
T _j			-40 ... 175	°C
Chopper - IGBT				
V _{CES}	T _j = 25 °C		1200	V
I _C	T _j = 150 °C	T _s = 25 °C	12	A
		T _s = 70 °C	12	A
I _C	T _j = 175 °C	T _s = 25 °C	12	A
		T _s = 70 °C	12	A
I _{Cnom}			8	A
I _{CRM}	I _{CRM} = 3 x I _{Cnom}		24	A
V _{GES}			-20 ... 20	V
t _{psc}	V _{CC} = 800 V V _{GE} ≤ 15 V V _{CES} ≤ 1200 V	T _j = 150 °C	10	µs
T _j			-40 ... 175	°C
Inverse - Diode				
V _{RRM}	T _j = 25 °C		1200	V
I _F	T _j = 150 °C	T _s = 25 °C	14	A
		T _s = 70 °C	11	A
I _F	T _j = 175 °C	T _s = 25 °C	15	A
		T _s = 70 °C	12	A
I _{Fnom}			8	A
I _{FRM}	I _{FRM} = 3 x I _{Fnom}		24	A
I _{FSM}	t _p = 10 ms, sin 180°, T _j = 150 °C		36	A
T _j			-40 ... 175	°C
Freewheeling - Diode				
V _{RRM}	T _j = 25 °C		1200	V
I _F	T _j = 150 °C	T _s = 25 °C	14	A
		T _s = 70 °C	11	A
I _F	T _j = 175 °C	T _s = 25 °C	15	A
		T _s = 70 °C	12	A
I _{Fnom}			8	A
I _{FRM}	I _{FRM} = 3 x I _{Fnom}		24	A
I _{FSM}	t _p = 10 ms, sin 180°, T _j = 150 °C		36	A
T _i			-40 ... 175	°C



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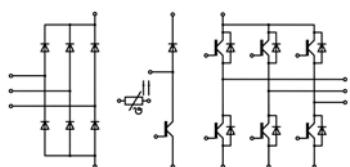
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Absolute Maximum Ratings

Symbol	Conditions	Values	Unit
Rectifier - Diode			
V_{RRM}	$T_j = 25^\circ\text{C}$	1600	V
I_F	$T_s = 25^\circ\text{C}$, $T_j = 150^\circ\text{C}$	39	A
I_{Fnom}		8	A
I_{FSM}	10 ms	$T_j = 25^\circ\text{C}$	A
	sin 180°	$T_j = 150^\circ\text{C}$	A
I^2t	10 ms	$T_j = 25^\circ\text{C}$	A^2s
	sin 180°	$T_j = 150^\circ\text{C}$	A^2s
T_j		$-40 \dots 150$	$^\circ\text{C}$
Module			
$I_{t(RMS)}$	$T_{terminal} = 80^\circ\text{C}$, 20A per spring	20	A
T_{stg}		$-40 \dots 125$	$^\circ\text{C}$
V_{isol}	AC sinus 50Hz, 1 min	2500	V

Characteristics

Symbol	Conditions	min.	typ.	max.	Unit
Inverter - IGBT					
$V_{CE(sat)}$	$I_C = 8\text{ A}$				
	$V_{GE} = 15\text{ V}$ chiplevel				
V_{CE0}					
r_{CE}	$V_{GE} = 15\text{ V}$				
$V_{GE(th)}$	$V_{GE} = V_{CE}\text{ V}$, $I_C = 1\text{ mA}$	5	5.8	6.5	V
I_{CES}	$V_{GE} = 0\text{ V}$				
	$V_{CE} = 1200\text{ V}$				
C_{ies}	$V_{CE} = 25\text{ V}$				
C_{oes}	$V_{GE} = 0\text{ V}$				
C_{res}					
Q_G	$-8\text{ V} \dots +15\text{ V}$		45		nC
R_{Gint}	$T_j = 25^\circ\text{C}$		0.00		Ω
$t_{d(on)}$	$V_{CC} = 600\text{ V}$				
t_r	$I_C = 8\text{ A}$				
E_{on}	$R_{G on} = 47\text{ }\Omega$				
$t_{d(off)}$	$R_{G off} = 47\text{ }\Omega$				
t_f					
E_{off}	$V_{GE} = +15/-15\text{ V}$				
$R_{th(j-s)}$	per IGBT		1.84		K/W
Chopper - IGBT					
$V_{CE(sat)}$	$I_C = 8\text{ A}$				
	$V_{GE} = 15\text{ V}$ chiplevel				
V_{CE0}					
r_{CE}	$V_{GE} = 15\text{ V}$				
$V_{GE(th)}$	$V_{GE} = V_{CE}\text{ V}$, $I_C = 1\text{ mA}$	5	5.8	6.5	V
I_{CES}	$V_{GE} = 0\text{ V}$				
	$V_{CE} = 1200\text{ V}$				
Q_G	$-8\text{ V} \dots +15\text{ V}$		45		nC
R_{Gint}	$T_j = 25^\circ\text{C}$		0.00		Ω

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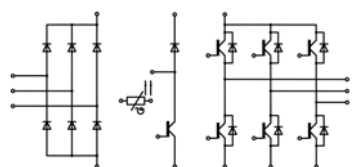
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Characteristics					
Symbol	Conditions		min.	typ.	max. Unit
Chopper - IGBT					
$t_{d(on)}$	$V_{CC} = 600\text{ V}$	$T_j = 150^\circ\text{C}$		31	ns
t_r	$I_C = 8\text{ A}$	$T_j = 150^\circ\text{C}$		31	ns
E_{on}	$R_{G\ on} = 47\ \Omega$	$T_j = 150^\circ\text{C}$		0.87	mJ
$t_{d(off)}$	$R_{G\ off} = 47\ \Omega$	$T_j = 150^\circ\text{C}$		290	ns
t_f		$T_j = 150^\circ\text{C}$		70	ns
E_{off}	$V_{GE} = +15/-15\text{ V}$	$T_j = 150^\circ\text{C}$		0.74	mJ
$R_{th(j-s)}$	per IGBT			1.84	K/W
Inverse - Diode					
$V_F = V_{EC}$	$I_F = 8\text{ A}$	$T_j = 25^\circ\text{C}$		2.3	2.6 V
	$V_{GE} = 0\text{ V}$ chiplevel	$T_j = 150^\circ\text{C}$		2.4	2.7 V
V_{F0}		$T_j = 25^\circ\text{C}$		1.3	1.5 V
		$T_j = 150^\circ\text{C}$		0.9	1.1 V
r_F		$T_j = 25^\circ\text{C}$		129	144 m Ω
		$T_j = 150^\circ\text{C}$		181	198 m Ω
I_{RRM}	$I_F = 8\text{ A}$	$T_j = 150^\circ\text{C}$		8.3	A
Q_{rr}	$di/dt_{off} = 380\text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$		1.35	μC
E_{rr}	$V_{GE} = -15\text{ V}$ $V_{CC} = 600\text{ V}$	$T_j = 150^\circ\text{C}$		0.57	mJ
$R_{th(j-s)}$	per Diode			2.53	K/W
Freewheeling - Diode					
$V_F = V_{EC}$	$I_F = 8\text{ A}$	$T_j = 25^\circ\text{C}$		2.3	2.6 V
	$V_{GE} = 0\text{ V}$ chiplevel	$T_j = 150^\circ\text{C}$		2.4	2.7 V
V_{F0}		$T_j = 25^\circ\text{C}$		1.3	1.5 V
		$T_j = 150^\circ\text{C}$		0.9	1.1 V
r_F		$T_j = 25^\circ\text{C}$		129	144 m Ω
		$T_j = 150^\circ\text{C}$		181	198 m Ω
I_{RRM}	$I_F = 8\text{ A}$	$T_j = 150^\circ\text{C}$		8.3	A
Q_{rr}	$di/dt_{off} = 380\text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$		1.35	μC
E_{rr}	$V_{GE} = -15\text{ V}$ $V_{CC} = 600\text{ V}$	$T_j = 150^\circ\text{C}$		0.57	mJ
$R_{th(j-s)}$	per Diode			2.53	K/W
Rectifier - Diode					
$V_F = V_{EC}$	$I_F = 8\text{ A}$	$T_j = 25^\circ\text{C}$		1	1.21 V
	$V_{GE} = 0\text{ V}$ chiplevel	$T_j = 125^\circ\text{C}$			1.1 V
V_{F0}		$T_j = 25^\circ\text{C}$			1.0 V
		$T_j = 125^\circ\text{C}$			0.8 V
r_F		$T_j = 25^\circ\text{C}$		15	29 m Ω
		$T_j = 125^\circ\text{C}$			34 m Ω
$R_{th(j-s)}$	per Diode			1.5	K/W
Module					
M_s	to heat sink		2		2.5 Nm
w				35	g
Temperatur Sensor					
R_{100}	$T_r = 100^\circ\text{C}$, tolerance = 3 %			$1670 \pm 3\%$	Ω
$R(T)$	$R(T) = 1000\Omega [1 + A(T - 25^\circ\text{C}) + B(T - 25^\circ\text{C})^2]$], $A = 7.635 \cdot 10^{-3} \text{ }^\circ\text{C}^{-1}$, $B = 1.731 \cdot 10^{-5} \text{ }^\circ\text{C}^{-2}$				

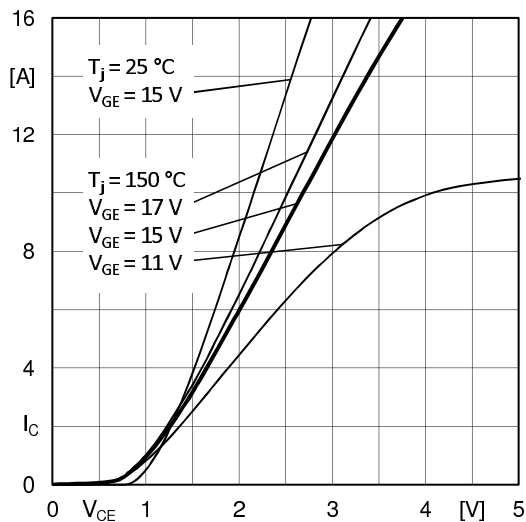


Fig. 1: Typ. output characteristic

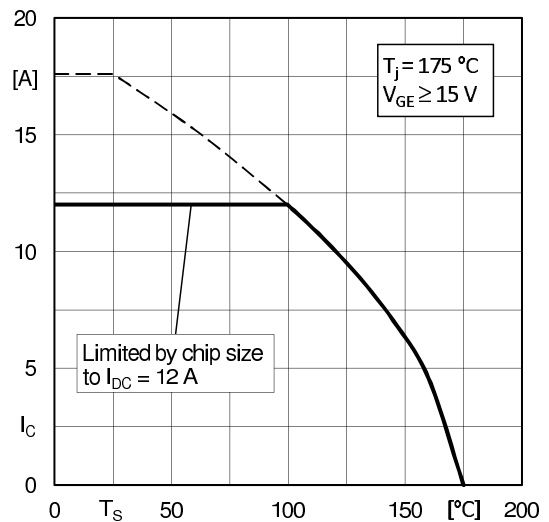


Fig. 2: Typ. rated current vs. temperature $I_C = f(T_S)$

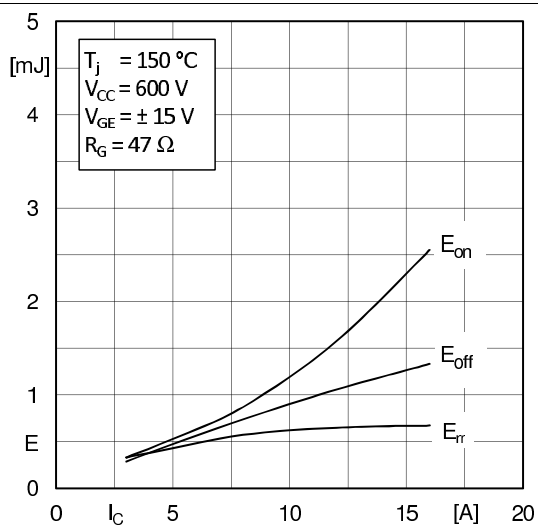


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

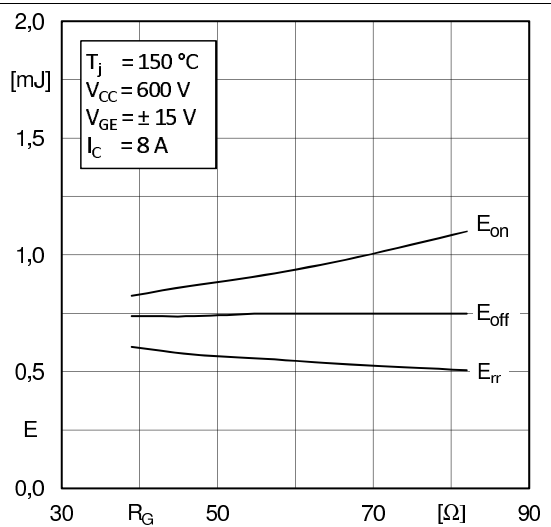


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

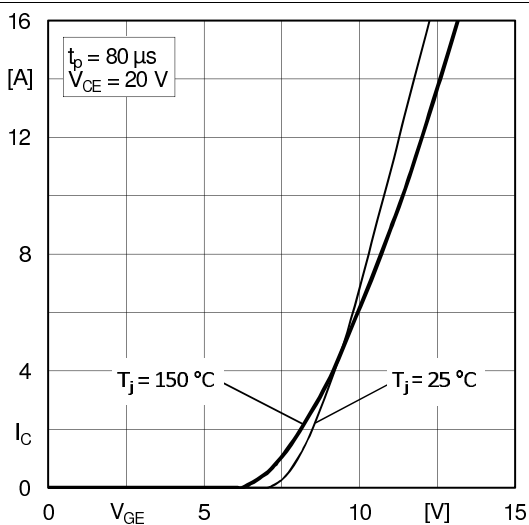


Fig. 5: Typ. transfer characteristic

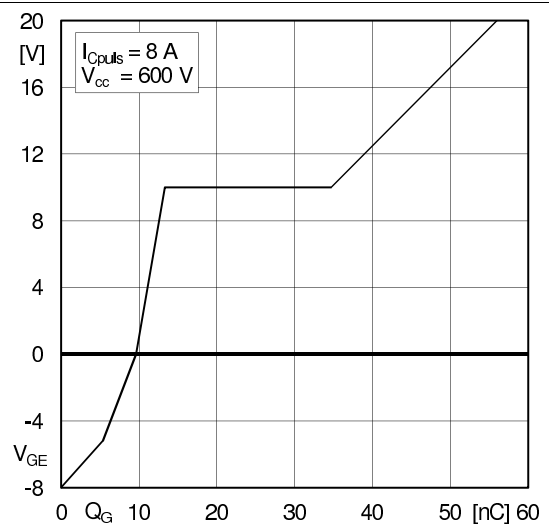
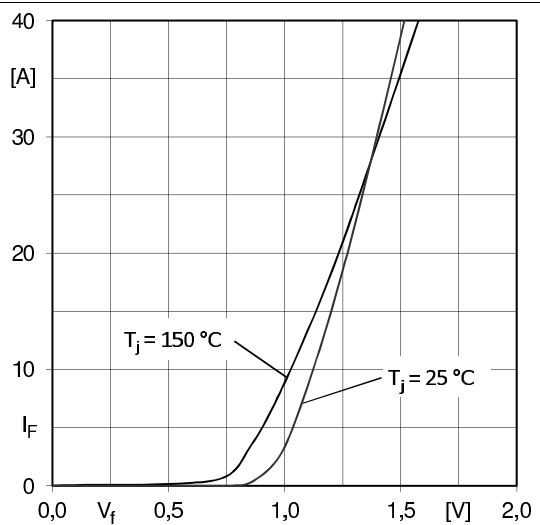
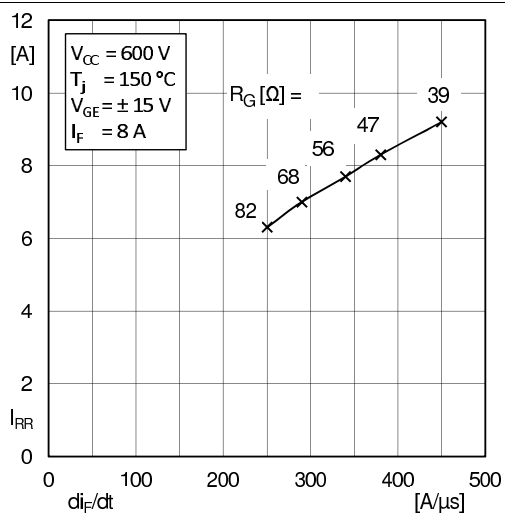
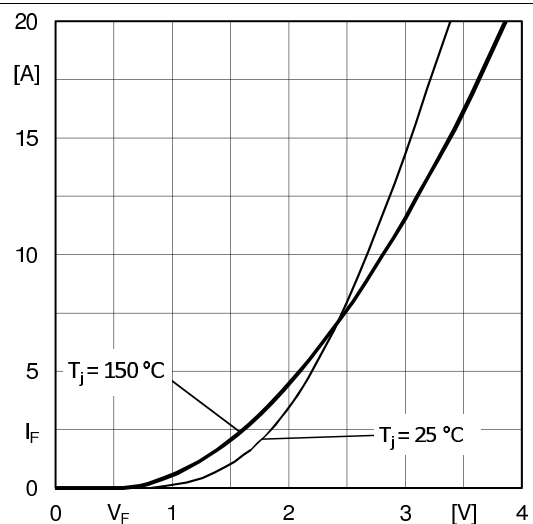
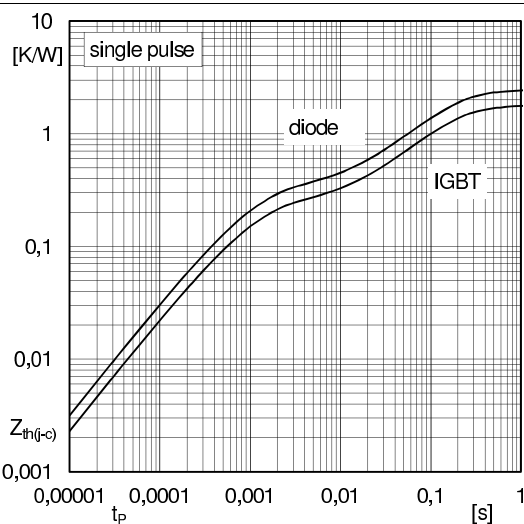
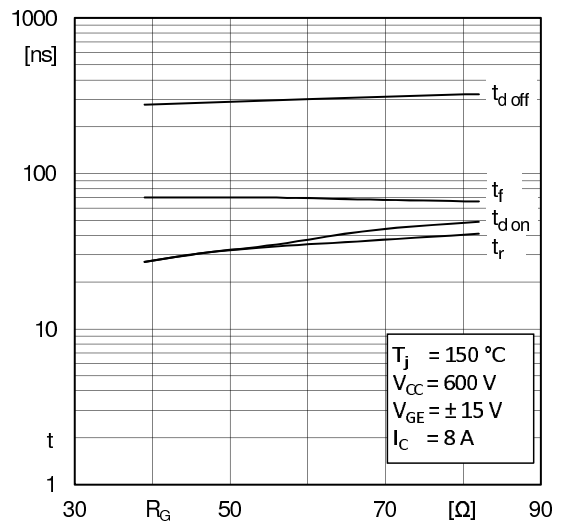
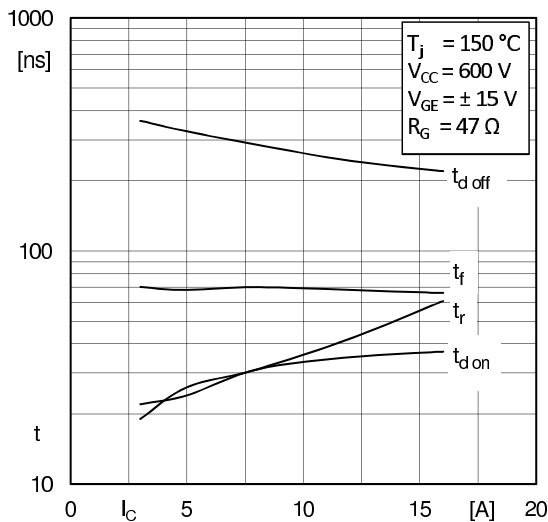
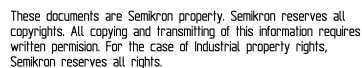


Fig. 6: Typ. gate charge characteristic





pinout, dimensions



* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.